



- NOTES
- ① 12 HATCHED PARTS: GROUND CIRCUIT.
  - ② 2 HATCHED PARTS: GROUND CIRCUIT.
  - 3 SMT LEAD-COPLANARITY: 0.1 MAX.
  - 4 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
  - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
  - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

4	PHOSPHOR BRONZE	TIN-PLATING	TIN-PLATING
3	PHOSPHOR BRONZE		CONTACT AREA: GOLD 0.1μm min.
			LEAD AREA: TIN-PLATING 1μm min.
2	PHOSPHOR BRONZE	TIN-PLATING	UNDER PLATING: NICKEL 1μm min.
1	LCP	BEIGE UL94V-0	
NO.	MATERIAL	FINISH	REMARKS

  

UNITS		SCALE	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
mm		4 : 1	△				
<b>HRS</b> HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	08.06.26	DRAWING NO.		EDC3-151950-25	
		CHECKED : HT. YAMAGUCHI	08.06.25	PART NO.		FX10B-120P/12-SV(71)	
		DESIGNED : SY. KAMIGA	08.06.23	CODE NO.		CL570-0023-8-71	
		DRAWN : HK. SUNADORI	08.06.17			△ 1/1	